

FCH043N60 N-Channel SuperFET[®] II MOSFET 600 V, 75 A, 43 mΩ

Features

- 650 V @ T_J = 150°C
- Typ. R_{DS(on)} = 37 mΩ
- Ultra Low Gate Charge (Typ. Q_g = 163 nC)
- Low Effective Output Capacitance (Typ. Coss(eff.) = 730 pF)
- 100% Avalanche Tested
- RoHS Compliant

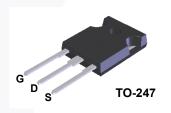
Applications

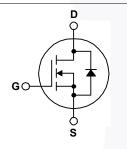
- Telecom / Sever Power Supplies
- Industrial Power Supplies



Description

SuperFET[®] II MOSFET is Fairchild Semiconductor's brand-new high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on-resistance and lower gate charge performance. This advanced technology is tailored to minimize conduction loss, provide superior switching performance, and withstand extreme dv/dt rate and higher avalanche energy. Consequently, SuperFET II MOSFET is suitable for various AC/DC power conversion for system miniaturization and higher efficiency.





Absolute Maximum Ratings T_C = 25°C unless otherwise noted.

Symbol		FCH043N60	Unit			
V _{DSS}	Drain to Source Voltage		600	V		
V _{GSS}	Cata ta Sauraa Maltaga	- DC		±20	V	
	Gate to Source Voltage	- AC	±30	V		
I _D	Drain Current	- Continuous (T _C = 25 ^o C)		75	Α	
	Drain Current	- Continuous (T _C = 100 ^o C)		47.5	- A	
I _{DM}	Drain Current	- Pulsed	(Note 1)	225	А	
E _{AS}	Single Pulsed Avalanche En	(Note 2)	2025	mJ		
I _{AR}	Avalanche Current	(Note 1)	15	А		
E _{AR}	Repetitive Avalanche Energy	(Note 1)	5.92	mJ		
dv/dt	MOSFET dv/dt		100	V/ns		
	Peak Diode Recovery dv/dt	20	v/ils			
P _D	Dower Dissingtion	(T _C = 25°C)		592	W	
	Power Dissipation	- Derate Above 25°C	4.74	W/ºC		
T _J , T _{STG}	Operating and Storage Temperature Range			-55 to +150	°C	
Τ _L	Maximum Lead Temperature 1/8" from Case for 5 Second		300	°C		

Thermal Characteristics

Symbol	Parameter	FCH043N60	Unit
$R_{ extsf{ heta}JC}$	Thermal Resistance, Junction to Case, Max.	0.21	°C/W
$R_{ extsf{ heta}JA}$	Thermal Resistance, Junction to Ambient, Max.	40	°C/vv

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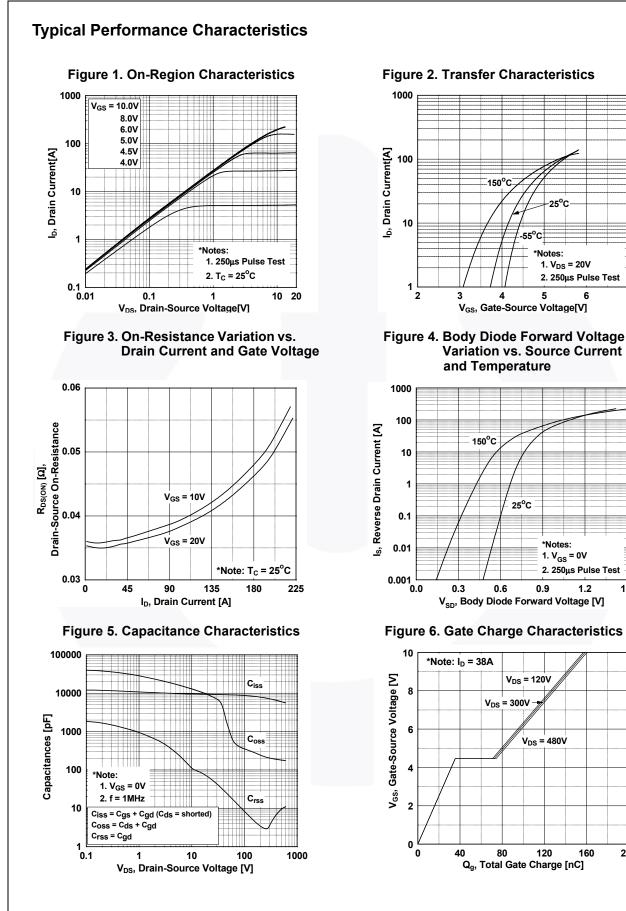
Part Number		Top Mark	Packag	ackage Packing Method Reel S		Reel Siz	e .	Fape Wid	th Qu	Quantity	
FCH043N60 FCH043N60 T			TO-24	D-247 Tube N/A			N/A 30 t) units	
Electrica	l Char	racteristics T _C = 25	5ºC unless	otherwi	se noted.						
Symbol		Parameter		Test Conditions			Min.	Тур.	Max.	Unit	
Off Charad	teristic	s									
		5		- 10 m/		- 2500	600				
BV _{DSS}			100	$I_D = 10 \text{ mA}, V_{GS} = 0 \text{ V}, T_C = 25^{\circ}\text{C}$			600 - · · · · · · · · · · · · · · · · · ·	-	V		
∆BV _{DSS}				$I_D = 10 \text{ mA}, V_{GS} = 0 \text{ V}, T_C = 150^{\circ}\text{C}$				050		-	
$/\Delta T_{J}$	Coeffici		۱ _D	= 10 m/	A, Referenced to	25°C	-	0.67	-	V/ºC	
, <u> </u>			V	V _{DS} = 600 V, V _{GS} = 0 V		-	-	1			
I _{DSS} Zero Ga		ate Voltage Drain Current		$V_{DS} = 480 \text{ V}, V_{GS} = 0 \text{ V}, T_{C} = 125^{\circ}\text{C}$			-	4.5	-	μA	
I _{GSS}	Gate to Body Leakage Current				V, V _{DS} = 0 V	,	-	-	±100	nA	
	toriatia	c								1	
On Charac		-		- 1/	L = 250 ··· A		0 F		9 F	17	
V _{GS(th)}		nreshold Voltage rain to Source On Resista	-		$_{\rm S}$, $I_{\rm D}$ = 250 μ A		2.5	- 37	3.5 43	V m0	
R _{DS(on)}		d Transconductance	-	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 38 \text{ A}$ $V_{DS} = 20 \text{ V}, \text{ I}_{D} = 38 \text{ A}$			-	73	43	mΩ S	
9 _{FS}	TOIWard	Transconductance	vD	_{DS} - 20 V	7, 1 _D – 30 A		-	75	-	3	
Dynamic (Characte	eristics									
C _{iss}	Input Ca	apacitance		V _{DS} = 400 V, V _{GS} = 0 V, f = 1 MHz			-	9194	12225	pF	
C _{oss}	Output	Capacitance				-	353	470	pF		
C _{rss}	Reverse	e Transfer Capacitance					-	11	16	pF	
C _{oss} eff.	Effective	e Output Capacitance	VD	_{os} = 0 V	to 480 V, V _{GS} =	0 V	-	730	-	pF	
Q _{g(tot)}	Total Ga	ate Charge at 10V	Vn	V _{DS} = 380 V, I _D = 38 A, V _{GS} = 10 V			-	163	215	nC	
Q _{gs}	Gate to	Source Gate Charge				-	35	-	nC		
Q _{gd}	Gate to	Drain "Miller" Charge				(Note 4)	-	39	-	nC	
ESR	Equivale	ent Series Resistance	f =	1 MHz			-	1.1	-	Ω	
Switching	Charac	toristics									
	T	Delay Time					-	46	102	ns	
t _{d(on)}		Rise Time	V	ь = 380	V, I _D = 38 A,	-		36	82	ns	
t _r		Delay Time		$V_{GS} = 10 \text{ V}, \text{ R}_{G} = 4.7 \Omega$			162	334	ns		
t _{d(off)} t _f		Fall Time				(Note 4)		6	-	ns	
						(11010 4)		Ŭ		110	
Drain-Sou	rce Dio	de Characteristics									
Is	Maximum Continuous Drain to Source Diode Forward Current					-	-	75	Α		
I _{SM}	Maximu	m Pulsed Drain to Source					-	-	225	Α	
V _{SD}	Drain to	Source Diode Forward V			/, I _{SD} = 38 A		-	-	1.2	V	
t _{rr}		Recovery Time			√, I _{SD} = 38 A,	-	-	605	-	ns	
Q _{rr}	Reverse	Recovery Charge	d	II _F /dt = 1	00 A/μs		-	16		μC	
2. I_{AS} = 15 A, R _G 3. $I_{SD} \le 38$ A, di/di	= 25 Ω, startin : ≤ 200 A/μs, \	limited by maximum junction tem lg $T_J = 25^{\circ}C$. $V_{DD} \le 380V$, starting $T_J = 25^{\circ}C$. berating temperature.	perature.								

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1.2

1.5

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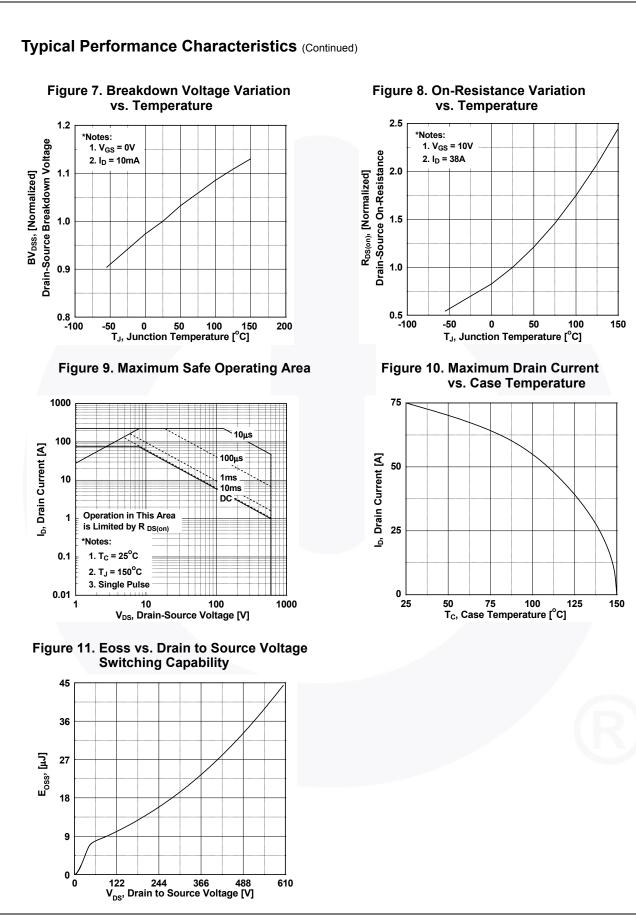
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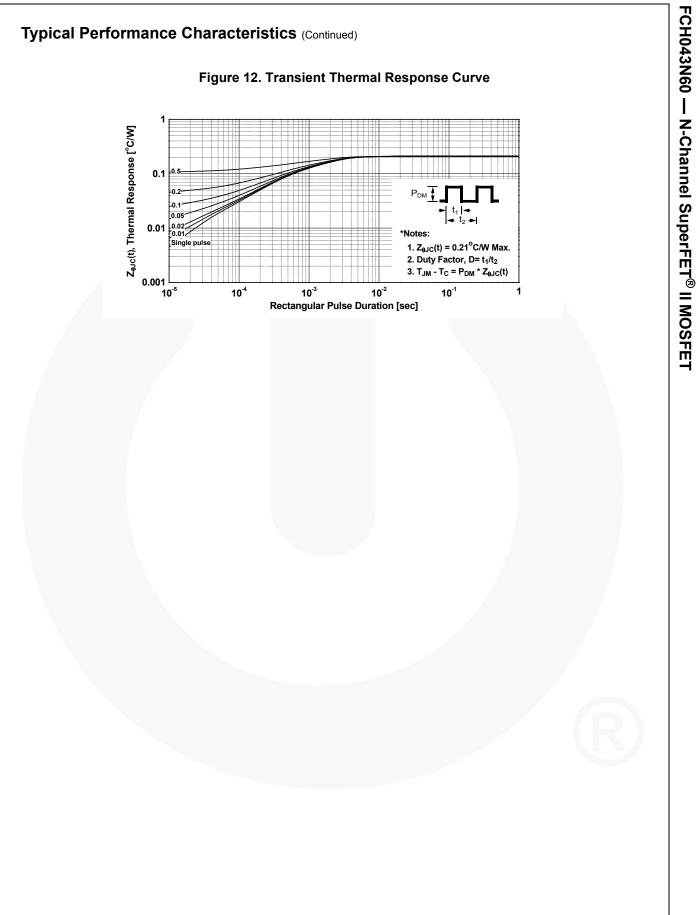
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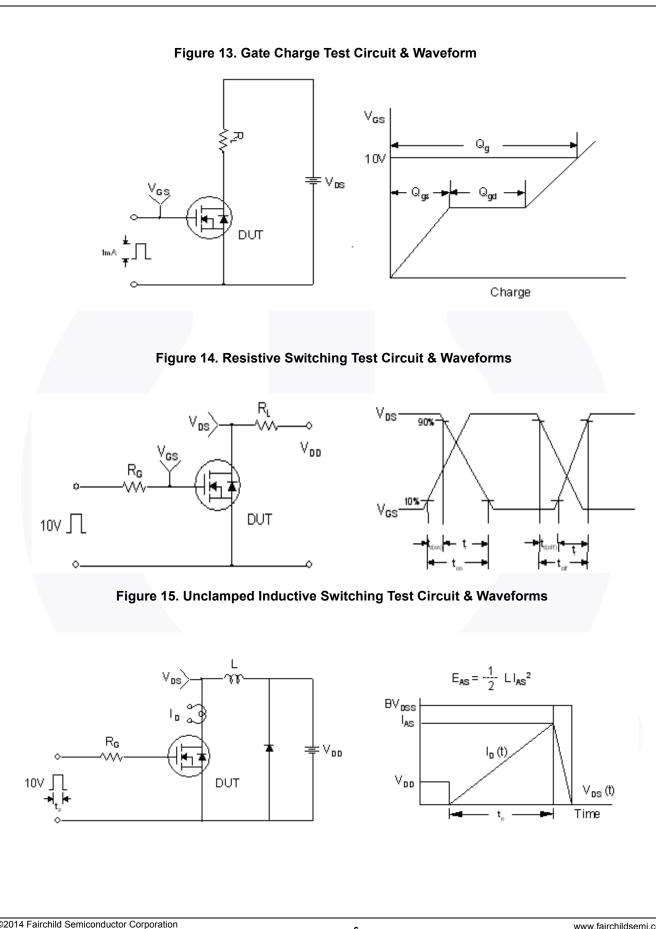
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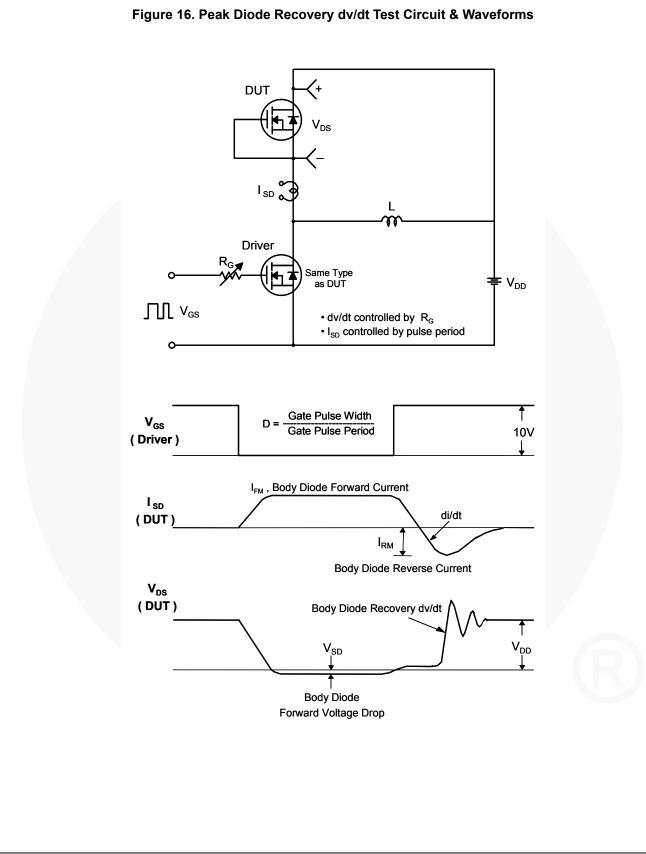
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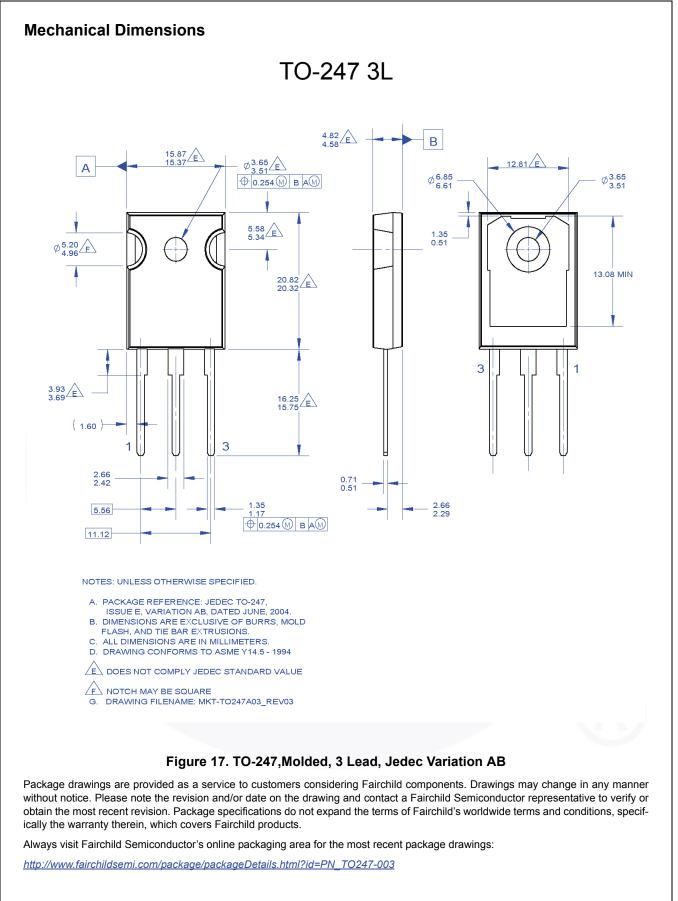
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